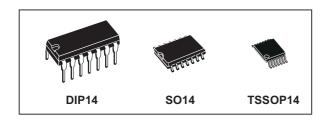


Hex inverter

Datasheet - production data



Features

- High speed:
 t_{PD} = 8 ns (typ.) at V_{CC} = 6 V
- Low power dissipation:
 I_{CC} = 1 μA (max.) at T_A = 25 °C
- High noise immunity:
 V_{NIH} = V_{NIL} = 28% V_{CC} (min.)
- Symmetrical output impedance:
 |I_{OH}| = I_{OL} = 4 mA (min) at V_{CC} = 4.5 V
- Balanced propagation delays: $t_{PLH} @ t_{PHL}$
- Wide operating voltage range:
 V_{CC} (OPR) = 2 V to 6 V
- Pin and function compatible with 74 series 04
- ESD performanceCDM: 1 kVHBM: 2 kV

– MM: 200 V

Description

The M74HC04 is a high-speed CMOS hex inverter manufactured using silicon gate C²MOS technology.

The internal circuit is composed of 3 stages including a buffer output which enables high noise immunity and stable output.

All inputs are equipped with protection circuits to guard against static discharge and transient excess voltage.

Table 1. Device summary

Order code	Temperature range	Package	Packaging	Marking
M74HC04B1R	-55 °C to +125 °C	DIP14	Tube	M74HC04B1
M74HC04YRM13TR ⁽¹⁾	-40 °C to +125 °C	SO14 (automotive grade)	Tape and reel	74HC04Y
M74HC04RM13TR	-55 °C to +125 °C	SO14	Tape and reel	74HC04
M74HC04TTR	-55 °C to +125 °C	TSSOP14	Tape and reel	HC04
M74HC04YTTR ⁽¹⁾	-40 °C to +125 °C	TSSOP14 (automotive grade)	Tape and reel	HC04Y

Qualification and characterization according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 and Q002 or equivalent.

Contents M74HC04

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M74HC04 Pin information

1 Pin information

Figure 1. Pin connections and IEC logic symbols

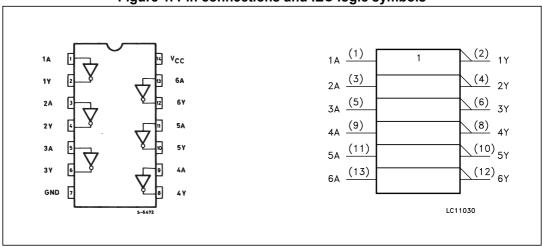


Table 2. Pin description

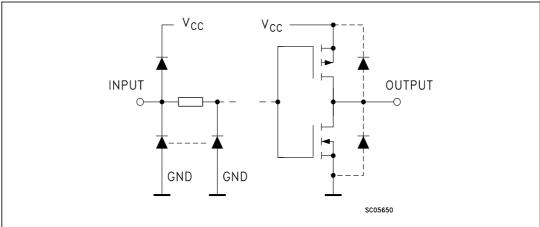
Pin number	Symbol	Name and function
1, 3, 5, 9, 11, 13	1A to 6A	Data inputs
2, 4, 6, 8, 10, 12	1Y to 6Y	Data outputs
7	GND	Ground (0 V)
14	V _{CC}	Positive supply voltage

2 Functional description

Table 3. Truth table

Α	Υ
L	Н
Н	L

Figure 2. Input and output equivalent circuit



3 Electrical characteristics

Stressing the device above the ratings listed in the "Absolute maximum ratings" table may cause permanent damage to the device. These are stress ratings only, and operation of the device at these or any other conditions above those indicated in the operating sections of this specification are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Table 4. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage	-0.5 to +7	V
V _I	DC input voltage	-0.5 to V _{CC} +0.5	V
V _O	DC output voltage	-0.5 to V _{CC} +0.5	V
I _{IK}	DC input diode current	±20	mA
I _{OK}	DC output diode current	±20	mA
I _O	DC output current	±25	mA
I _{CC or} I _{GND}	DC V _{CC} or ground current	±50	mA
P _D	Power dissipation	500 ⁽¹⁾	mW
T _{stg}	Storage temperature	-65 to +150	°C
T _L	Lead temperature (10 sec)	300	°C

^{1. 500} mW at 65 °C; derate to 300 mW by 10 mW/°C from 65 °C to 85 °C

Table 5. Recommended operating conditions

Symbol	Parameter	Value	Unit	
V _{CC}	Supply voltage		2 to 6	V
V _I	Input voltage	0 to V _{CC}	V	
V _o	Output voltage	0 to V _{CC}	V	
T _{op}	Operating temperature		-55 to 125	°C
		V _{CC} = 2.0 V	0 to 1000	ns
t _r , t _f	Input rise and fall time	V _{CC} = 4.5 V	0 to 500	ns
		V _{CC} = 6.0 V	0 to 400	ns

Electrical characteristics M74HC04

Table 6. DC specifications

		Test	condition	Value							
0	Danama atau			-	T _A = 25°C		-40 to 85°C		-55 to 125°C		11
Symbol	Parameter	V _{cc} (V)		Min.	Тур.	Max.	Min.	Max.	Min.	Max.	Unit
	High-level	2.0		1.5			1.5		1.5		
V _{IH}	input voltage	4.5		3.15			3.15		3.15		V
· III		6.0		4.2			4.2		4.2		
		2.0				0.5		0.5		0.5	
V _{IL}	Low-level input voltage	4.5				1.35		1.35		1.35	V
	par railage	6.0				1.8		1.8		1.8	
		2.0	I _O = -20 μA	1.9	2.0		1.9		1.9		
		4.5	I _O = -20 μA	4.4	4.5		4.4		4.4		
V _{OH}	High-level output voltage	6.0	I _O = -20 μA	5.9	6.0		5.9		5.9		V
	output voitago	4.5	I _O = -4.0 mA	4.18	4.31		4.13		4.10		
		6.0	I _O = -5.2 mA	5.68	5.8		5.63		5.60		
		2.0	I _O = 20 μA		0.0	0.1		0.1		0.1	
		4.5	I _O = 20 μA		0.0	0.1		0.1		0.1	
V _{OL}	Low-level output voltage	6.0	I _O = 20 μA		0.0	0.1		0.1		0.1	V
Output voltage	output roitage	4.5	I _O = 4.0 mA		0.17	0.26		0.33		0.40	V
		6.0	I _O = 5.2 mA		0.18	0.26		0.33		0.40	
I,	Input leakage current	6.0	V _I = V _{CC} or GND			± 0.1		± 1		± 1	μΑ
I _{cc}	Quiescent supply current	6.0	V _I = V _{CC} or GND			1		10		20	μΑ

Table 7. AC electrical characteristics $(C_1 = 50 \text{ pF}, \text{input } t_r = t_f = 6 \text{ ns})$

		Toe	t condition	ارمانو Value							
		103	Condition				value				
Symbol	Parameter	V 00		٦	Γ _A = 25°0		-40 to	85°C	-55 to	125°C	Unit
Symbol	Parameter	V _{cc} (V)		Min.	Тур.	Max.	Min.	Max.	Min.	Max.	
	Output	2.0			38	75		95		110	
t _{fLH} t _{fHL}	transition time	4.5			8	15		19		22	ns
		6.0			6	13		16		19	
		2.0			45	95		120		145	
t _{PLH} t _{PHL}	Propagation delay time	4.5			9	19		24		29	ns
	,	6.0			8	16		20		25	

Table 8. Capacitive characteristics

		Test co	ndition	on Value							
Cumbal	Doromotor	V 00		-	Γ _A = 25°C	;	-40 to	85°C	-55 to	125°C	11:4
Symbol	Parameter	V _{cc} (V)		Min.	Тур.	Max.	Min.	Max.	Min.	Max.	Unit
C _{IN}	Input capacitance	5.0			5	10		10		10	pF
C _{PD}	Power dissipation capacitance ⁽¹⁾	5.0			22						pF

CPD is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to the test circuit). Average operating current can be obtained by the following equation:

ICC(opr) = CPD x VCC x fIN + ICC/6 (per gate)



Electrical characteristics M74HC04

Figure 3. Test circuit

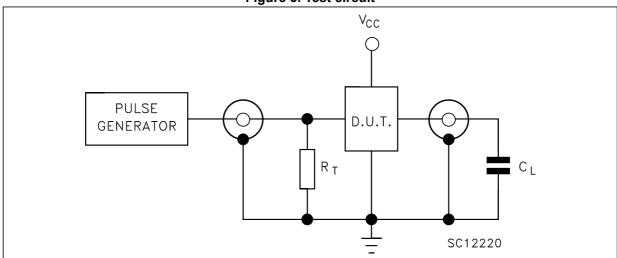
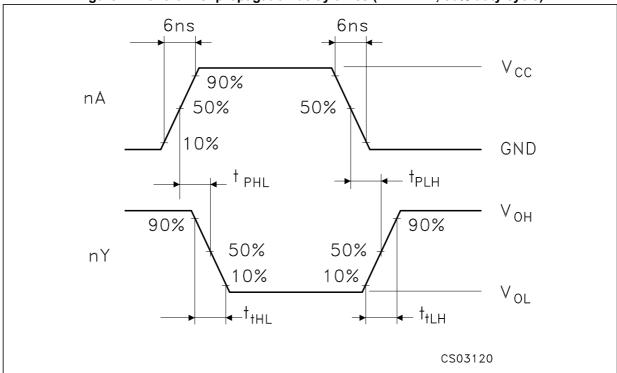


Figure 4. Waveforms: propagation delay times (f = 1 MHz; 50% duty cycle)



M74HC04 Package information

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

4.1 DIP14 package information

Figure 5. Plastic DIP14 package mechanical outline

Table 9. Plastic DIP14 package mechanical data

			<u> </u>			
Dimension		mm.			inches	
Dimension	Min.	Тур	Max.	Min.	Тур.	Max.
a1	0.51			0.020		
В	1.39		1.65	0.055		0.065
b		0.5			0.020	
b1		0.25			0.010	
D			20			0.787
E		8.5			0.335	
е		2.54			0.100	
e3		15.24			0.600	
F			7.1			0.280
1			5.1			0.201
L		3.3			0.130	
Z	1.27		2.54	0.050		0.100

Package information M74HC04

4.2 SO14 package information

Figure 6. Plastic SO14 package mechanical outline

Table 10. SO14 package mechanical data

GAMS0502131027CB

Table 10. 3014 package mechanical data								
Dof		mm.			inches			
Ref.	Min.	Тур	Max.	Min.	Тур.	Max.		
Α			1.75			0.068		
a1	0.1		0.2	0.003		0.007		
a2			1.65			0.064		
b	0.35		0.46	0.013		0.018		
b1	0.19		0.25	0.007		0.010		
С		0.5			0.019			
c1		•	45°	(typ.)	•			
D	8.55		8.75	0.336		0.344		
E	5.8		6.2	0.228		0.244		
е		1.27			0.050			
e3		7.62			0.300			
F	3.8		4.0	0.149		0.157		
G	4.6		5.3	0.181		0.208		
L	0.5		1.27	0.019		0.050		
М			0.68			0.026		
S		•	8° (max.)	•			

4.3 TSSOP14 package information

Figure 7. TSSOP14 package mechanical outline

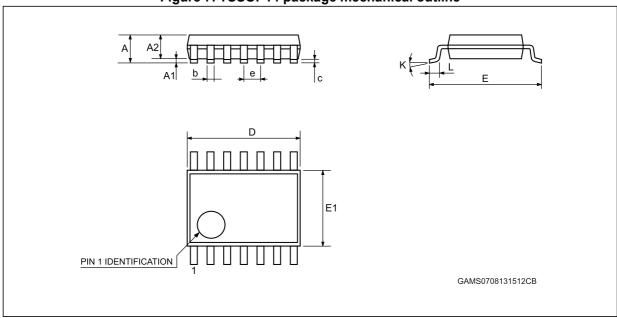


Table 11. TSSOP14 package mechanical data

Ref.		mm.		inches			
	Min.	Тур	Max.	Min.	Тур.	Max.	
А			1.2			0.047	
A1	0.05		0.15	0.002	0.004	0.006	
A2	0.8	1	1.05	0.031	0.039	0.041	
b	0.19		0.30	0.007		0.012	
С	0.09		0.20	0.004		0.0089	
D	4.9	5	5.1	0.193	0.197	0.201	
E	6.2	6.4	6.6	0.244	0.252	0.260	
E1	4.3	4.4	4.48	0.169	0.173	0.176	
е		0.65 BSC			0.0256 BSC		
K	0°		8°	0°		8°	
L	0.45	0.60	0.75	0.018	0.024	0.030	

Revision history M74HC04

5 Revision history

Table 12. Document revision history

Date	Revision	Changes
11-Sep-2013	3	Added ESD information to Features
		Added automotive grade order codes, temperature ranges, and marking information to <i>Table 1: Device summary</i>
		Revised document presentation
		Minor textual updates

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